Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904) ti.com/support Distribute - RoHS and IEC 62474 DB Contact Info: Form/Declaration Type: 06/14/2022 Created on:

Details for "LMH0071SQE/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LMH0071SQE/NOPB	SN	Level-3-260C-168 HR	Texas Instruments Electronics	RHS 48	7 x 7 x 0.8	145.3

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.414739	97.534929	975349	0.285523	2855
Nickel and Its Alloys	Nickel	7440-02-0	0.000002	0.00047	5	0.000001	0
Not Categorized	Proprietary Materials		0.000047	0.011053	111	0.000032	0
Precious Metals	Gold	7440-57-5	0.000219	0.051503	515	0.000151	2
Precious Metals	Palladium	7440-05-3	0.010202	2.399223	23992	0.007023	70
Precious Metals	Silver	7440-22-4	0.000012	0.002822	28	0.00008	0
Sub-Total			0.425221	100	1000000	0.292739	2927
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	2.012245	75.000009	750000	1.385309	13853
Thermoplastics	Ероху	85954-11-6	0.670748	24.999991	250000	0.461769	4618
Sub-Total			2.682993	100	1000000	1.847079	18471
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	79.22016	96	960000	54.538292	545383
Copper and Its Alloys	Iron	7439-89-6	2.145546	2.6	26000	1.477079	14771
Copper and Its Alloys	Phosphorus	7723-14-0	0.123782	0.150001	1500	0.085216	852
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.024756	0.03	300	0.017043	170
Precious Metals	Silver	7440-22-4	0.841714	1.02	10200	0.579469	5795
Zinc and Its Alloys	Zinc	7440-66-6	0.165042	0.2	2000	0.113621	1136
Sub-Total			82.521	100	1000000	56.81072	568107
Lead Frame Plating	•						
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.482	100	1000000	0.331828	3318
Sub-Total			0.482	100	1000000	0.331828	3318
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	47.421419	90.5	905000	32.646781	326468
Thermoplastics	Ероху	85954-11-6	4.977939	9.5	95000	3.42701	34270
Sub-Total			52.399358	100	1000000	36.073791	360738
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	6.745463	100	1000000	4.643844	46438
Sub-Total			6.745463	100	1000000	4.643844	46438
Total			145.256035			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one Ti part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different Ti part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

Ti certifies that the material content information provided by Ti is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. Ti semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/14/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szza088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet 15709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.